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Vishay Siliconix

### **Dual N-Channel 20 V (D-S) MOSFET**

## 

Marking code: CC

PRODUCT SUMMARY									
V <sub>DS</sub> (V)	20								
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS} = 4.5 \text{ V}$	0.046								
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS} = 2.5 \text{ V}$	0.063								
Q <sub>g</sub> typ. (nC)	3.5								
I <sub>D</sub> (A) <sup>a</sup>	4.5								
Configuration	Dual								

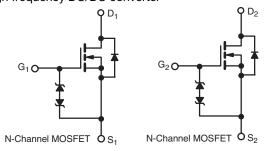
#### **FEATURES**

- TrenchFET® power MOSFET
- New thermally enhanced PowerPAK® SC-70 package
  - Small footprint area
  - Low on-resistance
- Typical ESD protection 560 V
- Material categorization: for definitions of compliance please see <a href="https://www.vishav.com/doc?99912"><u>www.vishav.com/doc?99912</u></a>

## ROHS COMPLIANT HALOGEN

#### **APPLICATIONS**

- · Load switch for portable applications
- High frequency DC/DC converter



ORDERING INFORMATION	
Package	PowerPAK SC-70
Lead (Pb)-free and halogen-free	SiA906EDJ-T1-GE3

PARAMETER		SYMBOL	LIMIT	UNIT		
Drain-source voltage		$V_{DS}$	20	V		
Gate-source voltage		V <sub>GS</sub>	± 12			
	T <sub>C</sub> = 25 °C		4.5 <sup>a</sup>			
Continuous drain surrent (T. 150 °C)	T <sub>C</sub> = 70 °C		4.5 <sup>a</sup>			
Continuous drain current (T <sub>J</sub> = 150 °C)	T <sub>A</sub> = 25 °C	I <sub>D</sub>	4.5 <sup>a, b, c</sup>			
	T <sub>A</sub> = 70 °C		4.1 <sup>b, c</sup>	Α		
Pulsed drain current		I <sub>DM</sub>	15			
Continuous source drain diade surrent	T <sub>C</sub> = 25 °C		4.5 <sup>a</sup>			
Continuous source-drain diode current	T <sub>A</sub> = 25 °C	I <sub>S</sub>	1.6 <sup>b, c</sup>			
	T <sub>C</sub> = 25 °C		7.8			
Manian and a state of	T <sub>C</sub> = 70 °C		5	w		
Maximum power dissipation	T <sub>A</sub> = 25 °C	P <sub>D</sub>	1.9 <sup>b, c</sup>	VV		
	T <sub>A</sub> = 70 °C		1.2 <sup>b, c</sup>			
Operating junction and storage temperature	T <sub>J</sub> , T <sub>stq</sub>	-55 to +150	°C			
Soldering recommendations (peak tempera	ture) <sup>d, e</sup>		260			

THERMAL RESISTANCE RATINGS									
PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT				
Maximum junction-to-ambient b, f	t ≤ 5 s	R <sub>thJA</sub>	52	65	°C/W				
Maximum junction-to-case (drain)	Steady state	$R_{thJC}$	12.5	16	C/VV				

#### Notes

- a. Package limited
- b. Surface mounted on 1" x 1" FR4 board
- c. t = 5 s
- d. See solder profile (<a href="www.vishay.com/doc?73257">www.vishay.com/doc?73257</a>). The PowerPAK SC-70 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection
- e. Rework conditions: manual soldering with a soldering iron is not recommended for leadless components
- f. Maximum under steady state conditions is 110 °C/W



#### SiA906EDJ

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PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static			•	•	•	
Drain-source breakdown voltage	$V_{DS}$	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	20	-	-	V
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$	J 050 A	-	23	-	mV/°C
V <sub>GS(th)</sub> temperature coefficient	$\Delta V_{GS(th)}/T_J$	I <sub>D</sub> = 250 μA	-	-3.3	-	
Gate-source threshold voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_D = 250 \mu A$	0.6	-	1.4	V
Gate-source leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 12 \text{ V}$	-	-	± 8	μA
Zava gata valtaga duain avuvant	I <sub>DSS</sub>	$V_{DS} = 20 \text{ V}, V_{GS} = 0 \text{ V}$	-	-	-1	
Zero gate voltage drain current		V <sub>DS</sub> = 20 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 55 °C	-	-	-10	
On-state drain current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \le 5 \text{ V}, V_{GS} = 4.5 \text{ V}$	10	-	-	Α
Duning and a state and interest 2	_ ` ′	$V_{GS} = 4.5 \text{ V}, I_D = 3.9 \text{ A}$	-	0.037	0.046	
Drain-source on-state resistance <sup>a</sup>	R <sub>DS(on)</sub>	$V_{GS} = 2.5 \text{ V}, I_D = 3.3 \text{ A}$	-	0.051	0.063	Ω
Forward transconductance a	9 <sub>fs</sub>	$V_{DS} = 10 \text{ V}, I_D = 3.9 \text{ A}$	-	14	-	S
Dynamic <sup>b</sup>			•	•	•	
Input capacitance	C <sub>iss</sub>		-	350	-	
Output capacitance	C <sub>oss</sub>	$V_{DS} = 10 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	-	63	-	pF
Reverse transfer capacitance	C <sub>rss</sub>		-	37	-	
Talal ada da a	Qg	V <sub>DS</sub> = 10 V, V <sub>GS</sub> = 10 V, I <sub>D</sub> = 5.1 A	-	7.5	12	nC
Total gate charge			-	3.5	5.5	
Gate-source charge	$Q_{gs}$	$V_{DS} = 10 \text{ V}, V_{GS} = 4.5 \text{ V}, I_D = 5.1 \text{ A}$	-	0.95	-	
Gate-drain charge	Q <sub>gd</sub>		-	0.75	-	
Gate resistance	R <sub>q</sub>	f = 1 MHz	0.7	3.5	7	Ω
Turn-on delay time	t <sub>d(on)</sub>		-	10	15	
Rise time	t <sub>r</sub>	$V_{DD} = 10 \text{ V}, R_{L} = 2.4 \Omega$	-	12	20	ns
Turn-off delay time	t <sub>d(off)</sub>	$I_D \cong 4.1 \text{ A}, V_{GEN} = 4.5 \text{ V}, R_g = 1 \Omega$	-	18	30	
Fall time	t <sub>f</sub>		-	12	20	
Turn-on delay time	t <sub>d(on)</sub>		-	5	10	
Rise time	t <sub>r</sub>	$V_{DD} = 10 \text{ V}, R_1 = 2.4 \Omega$	-	12	20	
Turn-off delay time	t <sub>d(off)</sub>	$I_D \cong 4.1 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$	-	15	25	
Fall time	t <sub>f</sub>		-	10	15	
<b>Drain-Source Body Diode Characteristic</b>	s			•	•	
Continuous source-drain diode current	I <sub>S</sub>	T <sub>C</sub> = 25 °C	-	-	4.5	
Pulse diode forward current I <sub>SM</sub>			-	-	15	A
Body diode voltage	ody diode voltage V <sub>SD</sub>		-	0.8	1.2	V
ody diode reverse recovery time $t_{rr}$		I <sub>S</sub> = 4.1 A, V <sub>GS</sub> = 0 V	-	15	30	ns
Body diode reverse recovery charge	Q <sub>rr</sub>	$I_F = 4.1 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s},$	-	8	20	nC
Reverse recovery fall time	t <sub>a</sub>	$T_J = 25  ^{\circ}\text{C}$	-	8	-	
Reverse recovery rise time	t <sub>b</sub>		-	7	_	ns

#### Notes

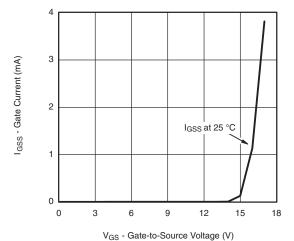
- a. Pulse test; pulse width  $\leq$  300  $\mu$ s, duty cycle  $\leq$  2 %
- b. Guaranteed by design, not subject to production testing

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

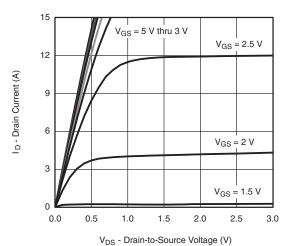
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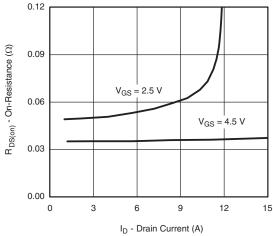
#### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



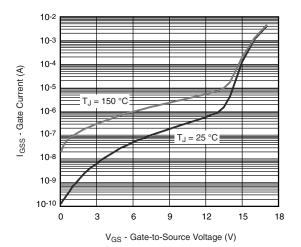
Gate Current vs. Gate-Source Voltage



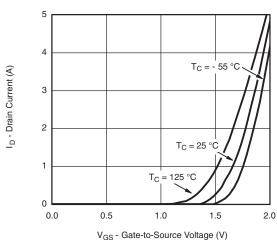
Output Characteristics



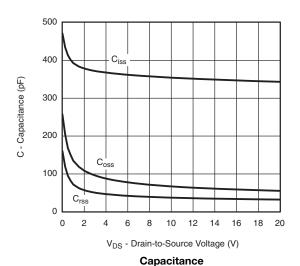
On-Resistance vs. Drain Current and Gate Voltage



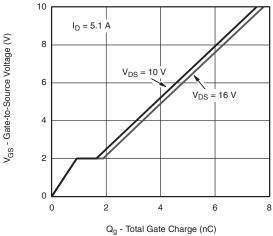
Gate Current vs. Gate-Source Voltage



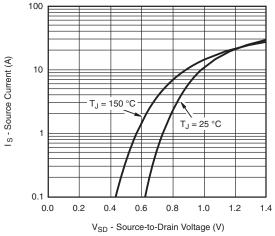
Transfer Characteristics



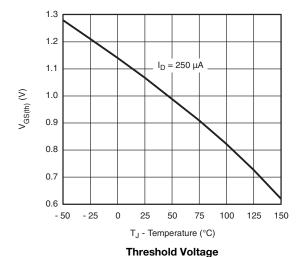
#### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



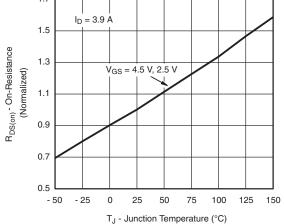




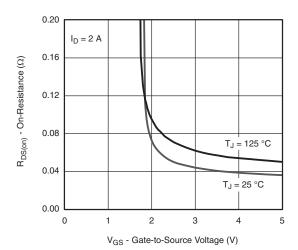
Source-Drain Diode Forward Voltage



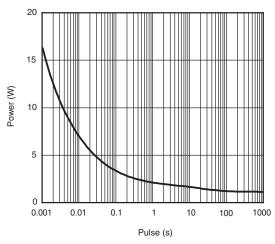
1.7



On-Resistance vs. Junction Temperature

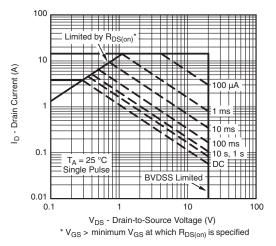


On-Resistance vs. Gate-to-Source Voltage

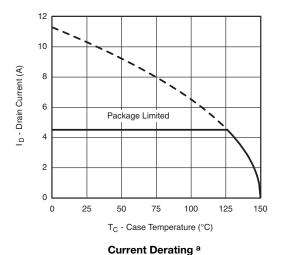


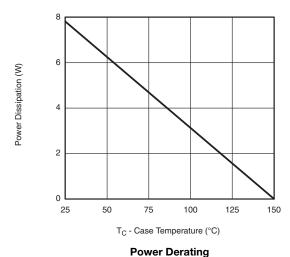
Single Pulse Power (Junction-to-Ambient)

#### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Safe Operating Area, Junction-to-Ambient



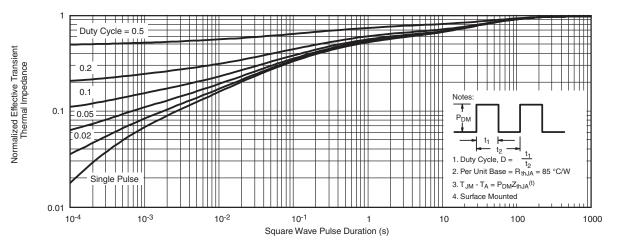


#### Note

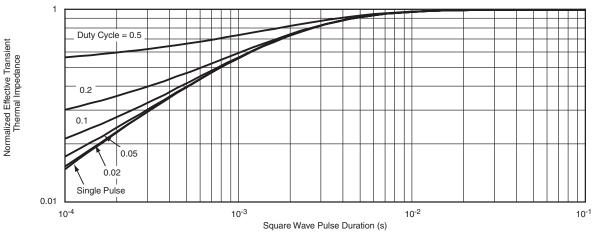
a. The power dissipation  $P_D$  is based on  $T_J$  max = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit



#### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



#### Normalized Thermal Transient Impedance, Junction-to-Ambient



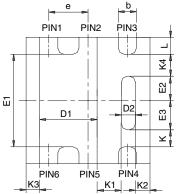
Normalized Thermal Transient Impedance, Junction-to-Foot

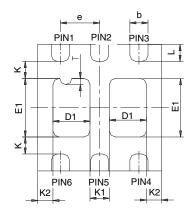
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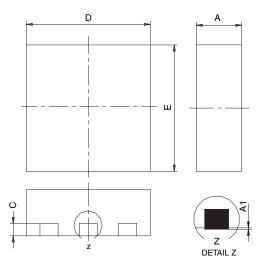
#### PowerPAK® SC70-6L





BACKSIDE VIEW OF SINGLE

BACKSIDE VIEW OF DUAL



- All dimensions are in millimeters
   Package outline exclusive of mold flash and metal burr
   Package outline inclusive of plating

	SINGLE PAD							DUAL PAD					
DIM	M	MILLIMETERS			INCHES			MILLIMETERS			INCHES		
	Min	Nom	Max	Min	Nom	Max	Min	Nom	Max	Min	Nom	Max	
Α	0.675	0.75	0.80	0.027	0.030	0.032	0.675	0.75	0.80	0.027	0.030	0.032	
A1	0	-	0.05	0	-	0.002	0	-	0.05	0	-	0.002	
b	0.23	0.30	0.38	0.009	0.012	0.015	0.23	0.30	0.38	0.009	0.012	0.015	
С	0.15	0.20	0.25	0.006	0.008	0.010	0.15	0.20	0.25	0.006	0.008	0.010	
D	1.98	2.05	2.15	0.078	0.081	0.085	1.98	2.05	2.15	0.078	0.081	0.085	
D1	0.85	0.95	1.05	0.033	0.037	0.041	0.513	0.613	0.713	0.020	0.024	0.028	
D2	0.135	0.235	0.335	0.005	0.009	0.013							
E	1.98	2.05	2.15	0.078	0.081	0.085	1.98	2.05	2.15	0.078	0.081	0.085	
E1	1.40	1.50	1.60	0.055	0.059	0.063	0.85	0.95	1.05	0.033	0.037	0.041	
E2	0.345	0.395	0.445	0.014	0.016	0.018							
E3	0.425	0.475	0.525	0.017	0.019	0.021							
е		0.65 BSC			0.026 BSC	;		0.65 BSC			0.026 BSC		
K		0.275 TYP			0.011 TYP	l	0.275 TYP			0.011 TYP			
K1		0.400 TYP			0.016 TYP		0.320 TYP			0.013 TYP			
K2		0.240 TYP			0.009 TYP		0.252 TYP			0.010 TYP			
К3		0.225 TYP		0.009 TYP									
K4		0.355 TYP		0.014 TYP									
L	0.175	0.275	0.375	0.007	0.011	0.015	0.175	0.275	0.375	0.007	0.011	0.015	
Т							0.05	0.10	0.15	0.002	0.004	0.006	
ECNI: C 0	7/21 Do	, C 06 Aug	1 07										

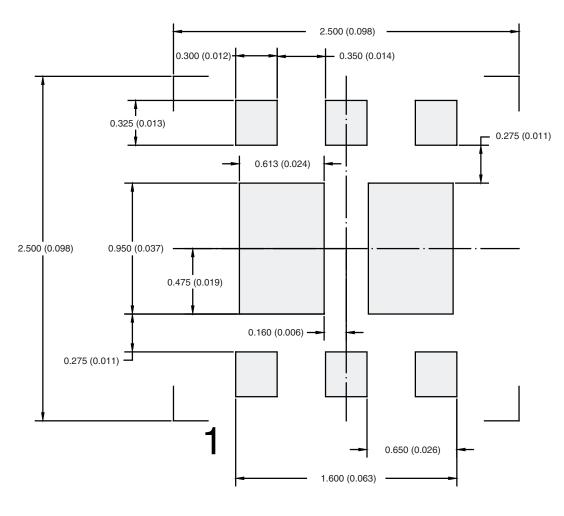
ECN: C-07431 - Rev. C, 06-Aug-07

DWG: 5934

Document Number: 73001 06-Aug-07

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#### RECOMMENDED PAD LAYOUT FOR PowerPAK® SC70-6L Dual



Dimensions in mm (inches)

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